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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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| In re the application of: |) | |
| |) | Group Art Unit: 1734 |
| Goldspring et al. |) | |
| |) | Examiner: AHMED, Shamim |
| Application No: 09/923,725 |) | |
| |) | Atty. Docket No: LAM2P267A |
| Filed: August 6, 2001 |) | |
| |) | Date: September 23, 2003 |
| For: METHOD AND APPARATUS FOR |) | |
| <u>SIMULATING STANDARD TEST WAFERS</u> |) | |

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on September 23, 2003.

Signed

Melinda M. Ward

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Dear Sir:

In response to the Office Action mailed on July 8, 2003, please enter the following amendments and remarks in the above-identified patent application:

Amendments to the specifications follow on page 2 of this paper.

Amendments to the claims are reflected in the listing of claims, which begins on page 3 of this paper.

Remarks/Arguments begin on page 5 of this paper.